

STS12N3LLH5

N-channel 30 V, 0.0068 Ω, 12 A, SO-8 STripFET™ V Power MOSFET

Datasheet — production data

Features

Туре	V _{DSS}	R _{DS(on)} max	I _D
STS12N3LLH5	30 V	< 0.0075 Ω	12 A ⁽¹⁾

- 1. The value is rated according $R_{thj-pcb}$
- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- Very low switching gate charge
- High avalanche ruggedness
- Low gate drive power losses

Application

Switching applications

Description

This device is an N-channel Power MOSFET developed using STMicroelectronics' STripFET™V technology. The device has been optimized to achieve very low on-state resistance, contributing to an FOM that is among the best in its class.

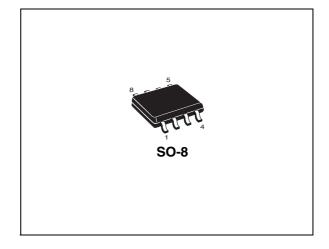


Figure 1. Internal schematic diagram

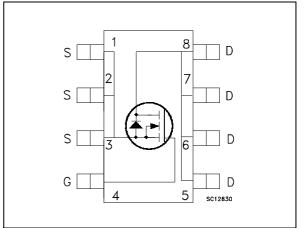


Table 1. **Device summary**

Order code	Marking	Package	Packaging	
STS12N3LLH5 12D3L		SO-8	Tape and reel	

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1 Electrical ratings

Table 2.	Absolute	maximum	ratings
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Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage ($V_{GS} = 0$)	30	V
V _{GS}	Gate-source voltage	+22/-20	V
I _D ⁽¹⁾	Drain current (continuous) at $T_C = 25 \ ^{\circ}C$	12	А
I _D ⁽¹⁾	Drain current (continuous) at T _C =100 °C	8.75	А
I _{DM} ⁽²⁾	Drain current (pulsed)	48	А
P _{TOT} ⁽²⁾	Total dissipation at $T_C = 25 \ ^{\circ}C$	2.7	W
	Derating factor	0.02	W/°C
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to 150	°C

1. The value is rated according $R_{thj\text{-}pcb}$

2. Pulse width limited by safe operating area

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-ambient	47	°C/W

1. When mounted on FR-4 board of 1inch², 2oz Cu, t < 10sec



2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

	On/on states					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 250 μA, V _{GS} = 0	30			۷
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = max rating, V _{DS} =max rating @125 °C			1 10	μΑ μΑ
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = +22/-20 V			±100	nA
V _{GS(th)}	Gate threshold voltage	V_{DS} = V_{GS} , I_D = 250 μ A	1			V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 6 A V _{GS} = 4.5 V, I _D = 6 A		0.0068 0.0084	0.0075 0.0092	Ω Ω

Table 4. On/off states

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} = 25 V, f=1 MHz, V _{GS} =0	-	1290 240 32		pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V _{DD} =15 V, I _D = 12 A V _{GS} = 4.5 V <i>Figure 14</i>	-	8 3.6 3.4		nC nC nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} =15 V, I _D = 6 A, R _G =4.7 Ω, V _{GS} =10 V <i>Figure 13</i>	-	8.6 11.2 32.4 6	-	ns ns ns ns



Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current		-		12	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		48	Α
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 12 \text{ A}, V_{GS} = 0$	-		1.1	V
t _{rr}	Reverse recovery time	I _{SD} = 12 A,		22		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/µs,	-	15		nC
I _{RRM}	Reverse recovery current	V _{DD} = 25 V, Tj=150 °C		1.4		Α

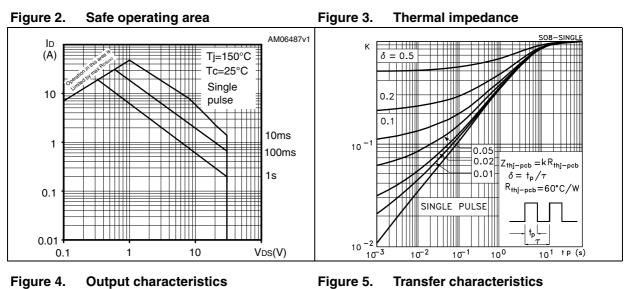
Table 7.Source drain diode

1. Pulse width limited by safe operating area

2. Pulsed: pulse duration=300 μ s, duty cycle 1.5%



2.1 Electrical characteristics (curves)



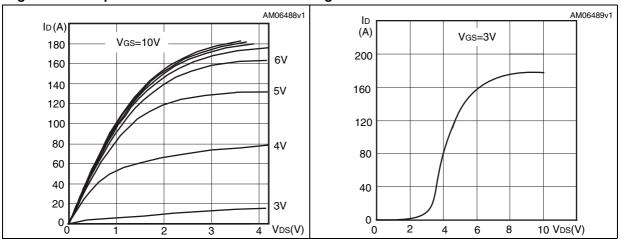
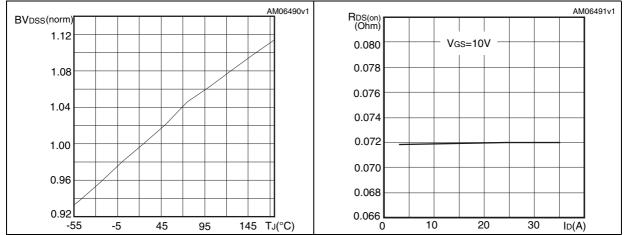
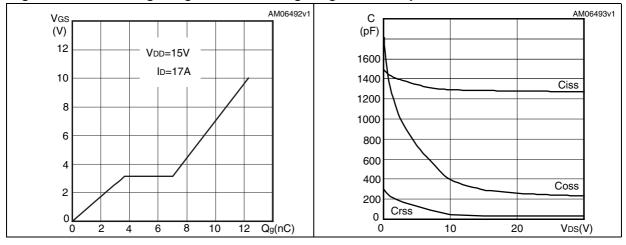




Figure 7. Static drain-source on-resistance

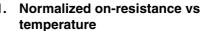






Gate charge vs gate-source voltage Figure 9. **Capacitance variations** Figure 8.

Figure 10. Normalized gate threshold voltage Figure 11. Normalized on-resistance vs vs temperature



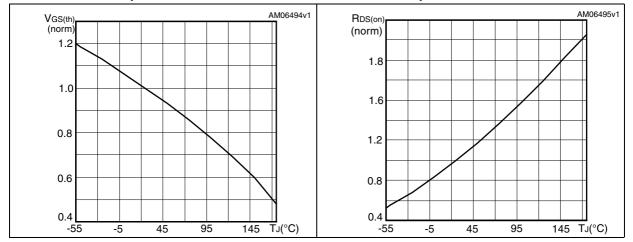
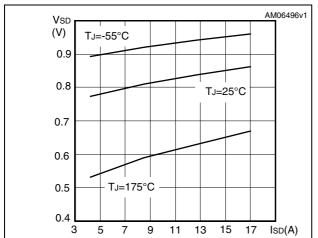


Figure 12. Source-drain diode forward characteristics

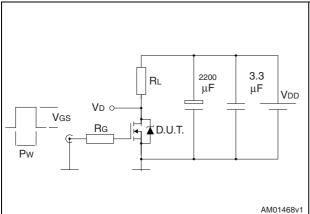


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3 Test circuits

Figure 13. Switching times test circuit for resistive load



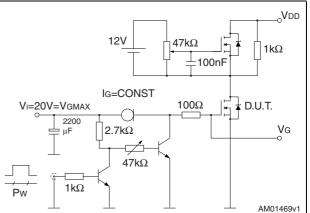
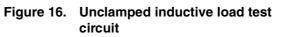
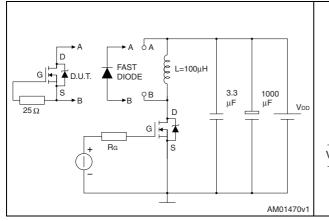


Figure 14. Gate charge test circuit

Figure 15. Test circuit for inductive load switching and diode recovery times





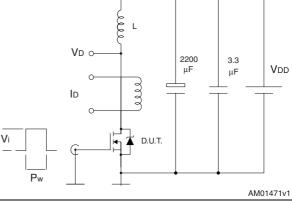
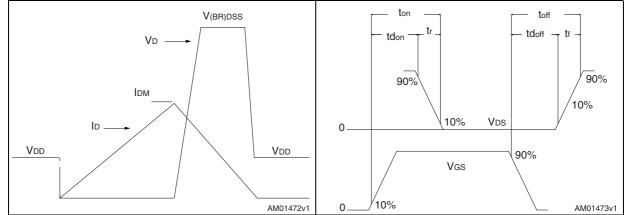




Figure 18. Switching time waveform



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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.



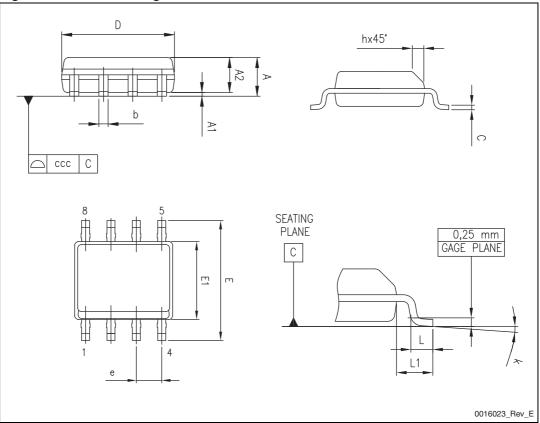
Dim.		mm	
	Min.	Тур.	Max.
A			1.75
A1	0.10		0.25
A2	1.25		
b	0.28		0.48
С	0.17		0.23
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
е		1.27	
h	0.25		0.50
L	0.40		1.27
L1		1.04	
k	0°		8°
CCC			0.10

Table 8.SO-8 mechanical data











5 Revision history

Table 9.Document revision history

Date	Revision	Changes
19-Feb-2010	1	First release.
01-Jul-2011	2	Datasheet status promoted from preliminary data to datasheet. Modified: <i>Table 2</i> and <i>4</i> .
07-Jun-2012	3	Updated mechanical data. Minor text changes.



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